CRMKTL3004A

N-Channel 30V, 2.8mΩ Typ. Power MOSFET

Description

Features

• 30V, 100A

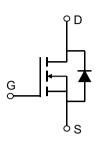
$$R_{DS(ON)}$$
 Typ = 2.8m Ω @ V_{GS} = 10V

$$R_{DS(ON)}$$
 Typ = $4m\Omega$ @ V_{GS} = 4.5V

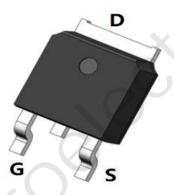
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

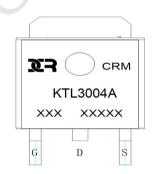
Application

- Load Switch
- PWM Application
- Power Management









Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTL3004A	CRMKTL3004A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	100	Α
I _D		T _C = 100°C	60	Α
I _{DM}	Pulsed Drain Current (1)		400	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		144	mJ
P_{D}	Power Dissipation	T _C = 25°C	65.7	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		1.9	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.6	2.2	V
R _{DS(ON)} S	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 30A$	-	2.8	3.8	mΩ
		$V_{GS} = 4.5V, I_D = 20A$	-	4	5.2	mΩ
Dynamic	Characteristics					
C_{iss}	Input Capacitance			3197	-	рF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X-\	355	-	pF
C_{rss}	Reverse Transfer Capacitance	1 111112		280	-	pF
Q_g	Total Gate Charge		U .	58	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 30A$	-	12	-	nC
Q_gd	Gate Drain("Miller") Charge	VDS 10V, ID COAT	-	13	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.r ()	-	11	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	29	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$, $R_{GEN} = 3\Omega$	-	47	-	ns
t _f	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	100	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	400	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 30A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 30A, di/dt = 100A/us	-	16	-	ns
Qrr	Body Diode Reverse Recovery Charge	i _F - SUA, di/dt - TUUA/US	-	7	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =24A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Typical Performance Characteristics

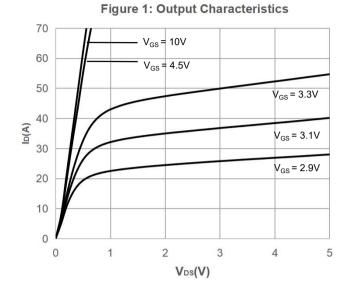


Figure 2: Typical Transfer Characteristics

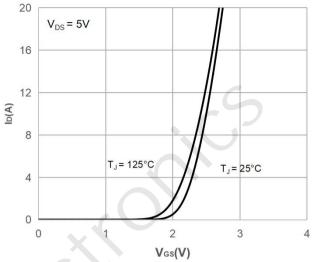


Figure 3: On-resistance vs. Drain Current

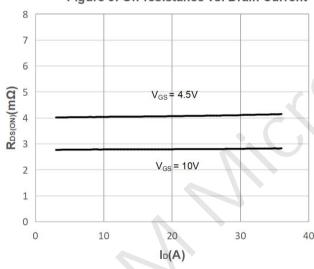


Figure 4: Body Diode Characteristics

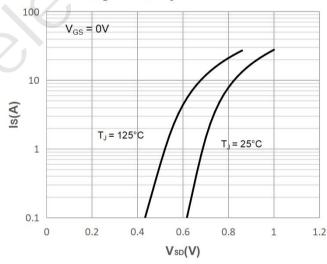


Figure 5: Gate Charge Characteristics

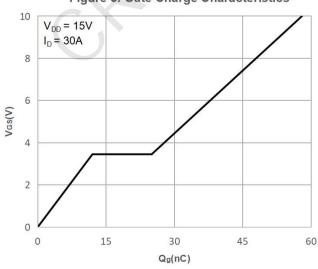
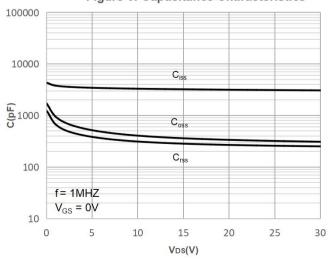


Figure 6: Capacitance Characteristics



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Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.

Junction Temperature

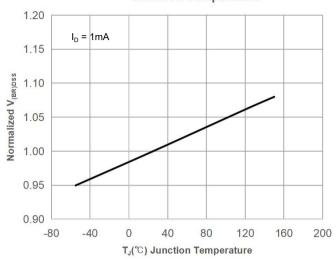


Figure 9: Maximum Safe Operating Area

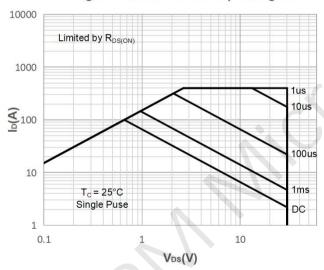


Figure 11: Normalized Maximum Transient

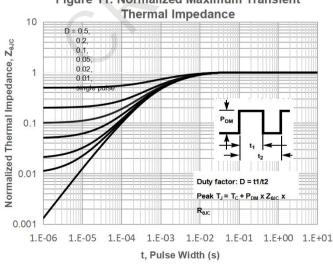


Figure 8: Normalized on Resistance vs.
Junction Temperature

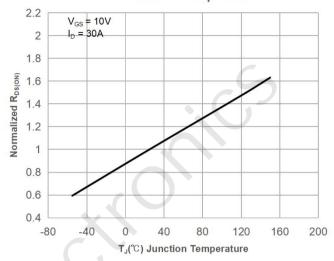


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

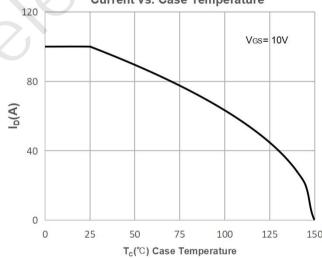
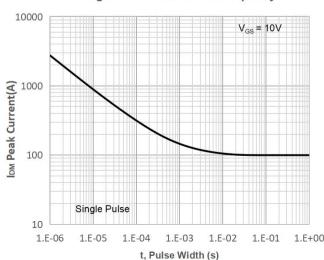


Figure 12: Peak Current Capacity



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Test Circuit

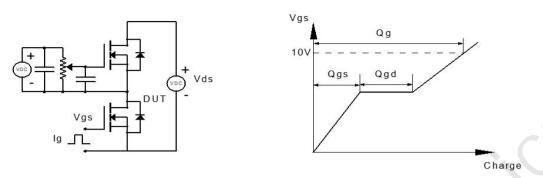


Figure 1: Gate Charge Test Circuit & Waveform

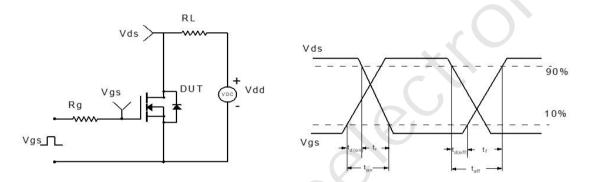


Figure 2: Resistive Switching Test Circuit & Waveform

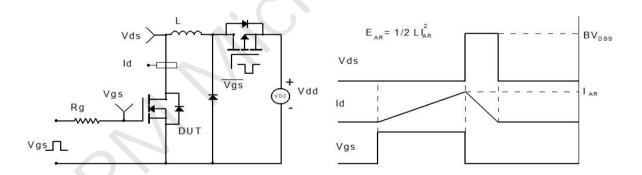


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

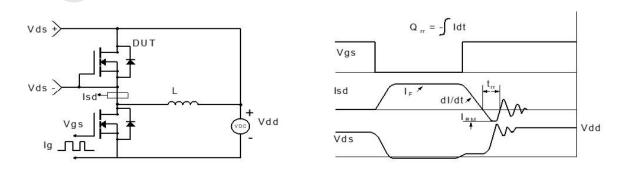
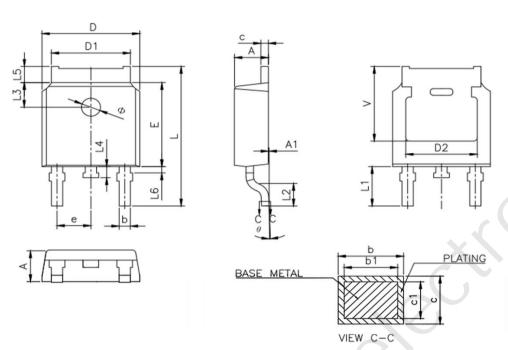


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-252-3L)



SYMBOL	MILLIMETER				
STWIDOL	MIN	NOM	MAX		
Α	2.20	2.30	2.40		
A1	0.00		0.127		
b	0.66		0.86		
b1	0.65	0.76	0.81		
D	6.50	6.60	6.70		
D1	5.10	5.33	5.46		
С	0.47		0.60		
c1	0.46	0.56			
D2	4.83 REF.				
E	6.00	6.10	6.20		
е	2.186	2.286	2.386		
L	9.80	10.10	10.40		
L1	2.90 REF.				
L2	1.40	1.50	1.60		
L3	1.80 REF.				
L4	0.60	0.80	1.00		
L5	0.90		1.25		
L6	0.15		0.75		
Ф	1.10		1.30		
θ	0.		8*		
V	V 5.40 REF				

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